



**Express Mail No. EV881853365US**

**Application Data Sheet**

**Application Information**

Application number::	10/555,899
U.S. Filing Date::	11/07/05
Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	1700
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	MICROELECTRONIC SUBSTRATES WITH THERMALLY CONDUCTIVE PATHWAYS AND METHODS OF MAKING SAME
Attorney Docket Number::	313688001US1
Request for Early Publication?::	No
Request for Non-Publication?::	No
Total Drawing Sheets::	4
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

**Applicant Information**

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Benny
Middle Name::	H.
Family Name::	Johnson

City of Residence:: Aloha  
State or Province of Residence:: OR  
Country of Residence:: US  
Street of mailing address:: 21200 S.W. Lawrence Lane  
City of mailing address:: Aloha  
State or Province of mailing address:: OR  
Postal or Zip Code of mailing address:: 97006

### **Correspondence Information**

Correspondence Customer Number:: 25096

### **Representative Information**

Representative Customer Number:: 25096

### **Domestic Priority Information**

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	US04/14209	05/07/04
US04/14209	An application claiming the benefit under 35 USC 119(e)	60/468,801	05/07/03

### **Foreign Priority Information**

### **Assignee Information**

Assignee name:: Merix Corporation  
Street of mailing address:: 1521 Poplar Lane  
City of mailing address:: Forest Grove  
State or Province of mailing address:: OR  
Postal or Zip Code of mailing address:: 97116